Product Specification

PE83511

DC - 1500 MHz Low Power UltraCMOS™ Divide-by-2 Prescaler
Military Operating Temperature Range

Product Description

The PE83511 is a high-performance static UltraCMOS™ prescaler with a fixed divide ratio of 2. Its operating frequency range is DC to 1500 MHz. The PE83511 operates on a nominal 3V supply and draws only 14 mA. It is packaged in a small 8-lead plastic MSOP and is ideal for frequency scaling and clock generation solutions.

The PE83511 is manufactured on Peregrine's UltraCMOS™ process, a patented variation of silicon-on-insulator (SOI) technology on a sapphire substrate, offering the performance of GaAs with the economy and integration of conventional CMOS.

Features

- DC to 1500 MHz operation
- Fixed divide ratio of 2
- Low-power operation:
  14 mA typical @ 3.0 V
- Ultra small package: 8-lead MSOP

Figure 1. Functional Schematic Diagram

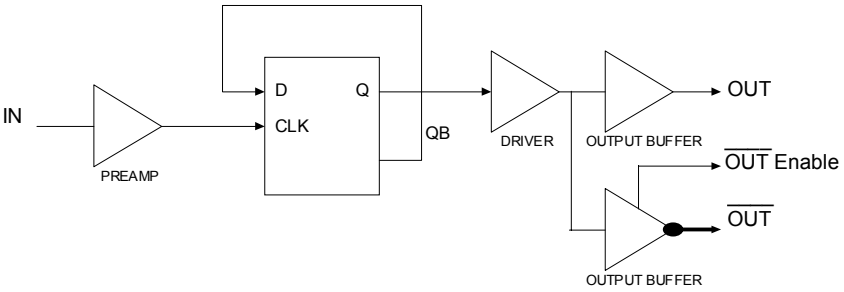


Figure 2. Package Type

8-lead MSOP

Table 1. Electrical Specifications ($Z_S = Z_L = 50\ \Omega$)

2.85 V ≤ V_{DD} ≤ 3.15 V; -55° C ≤ T_A ≤ 125° C, unless otherwise specified

Parameter	Conditions	Minimum	Typical	Maximum	Units
Supply Voltage		2.85	3.0	3.15	V
Supply Current	OUTB Disabled		7	12	mA
	OUTB Enabled		14	25	mA
Input Frequency (F_{IN})		DC		1500	MHz
Input Power (P_{IN})	100 MHz ≤ F_{in} ≤ 1200 MHz -55°C ≤ T_A ≤ 85°C	-5		+10	dBm
	100 MHz ≤ F_{in} ≤ 1200 MHz 85°C ≥ T_A ≥ 125°C	0		+10	dBm
	1200 MHz < F_{in} ≤ 1500 MHz -55°C ≤ T_A ≤ 85°C	+5		+10	dBm
Output Power	DC < Fin ≤ 1500 MHz	+2			dBm

Figure 3. Pin Configuration (Top View)

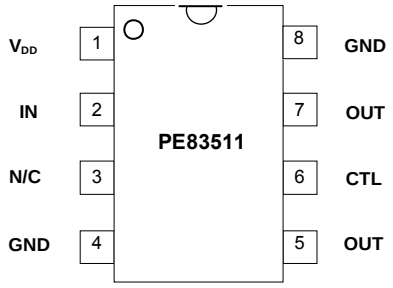


Table 2. Pin Descriptions

Pin No.	Pin Name	Description
1	V_{DD}	Power supply pin. Bypassing is required (eg 1000 pF & 100 pF).
2	IN	Input signal pin. Should be coupled with a capacitor (eg 1000 pF).
3	N/C	No connection. This pin should be left open.
4	GND	Ground pin. Ground pattern on the board should be as wide as possible to reduce ground impedance.
5	OUTB	Inverted divided frequency output. This pin should be coupled with a capacitor (eg 1000 pF).
6	CTL	Control pin. When grounded OUTB is enabled.
7	OUT	Divided frequency output. This pin should be coupled with a capacitor (eg 1000 pF).
8	GND	Ground Pin.

Table 3. Absolute Maximum Ratings

Symbol	Parameter/Conditions	Min	Max	Units
VDD	Supply voltage		4.0	V
P_{in}	Input Power		15	dBm
V_{IN}	Voltage on input	-0.3	VDD +0.3	V
T_{ST}	Storage temperature range	-65	150	°C
T_{OP}	Operating temperature range	-55	125	°C
VESD	ESD voltage (Human Body Model, MIL-STD 883)		2000	V

Absolute Maximum Ratings are those values listed in the above table. Exceeding these values may cause permanent device damage. Exposure to absolute maximum ratings for extended periods may affect device reliability.

Electrostatic Discharge (ESD) Precautions

When handling this UltraCMOS™ device, observe the same precautions that you would use with other ESD-sensitive devices. Although this device contains circuitry to protect it from damage due to ESD, precautions should be taken to avoid exceeding the rating specified in Table 3.

Latch-Up Avoidance

Unlike conventional CMOS devices, UltraCMOS™ devices are immune to latch-up.

Device Functional Considerations

The *PE83511* divides an input signal, up to a frequency of 1500 MHz, by a factor of two thereby producing an output frequency at half the input frequency. To work properly at higher frequency, the input and output signals (pins 2, 7 & optional 5) must be AC coupled via an external capacitor. The input may be DC coupled for low frequency operation with care taken to remain within the specified DC input range for the device.

The ground pattern on the board should be made as wide as possible to minimize ground impedance. See Figure 8 for a layout example.

OUTB Control

Pin 6 controls whether OUTB is enabled or disabled. Pin 6 has an internal pull-up resistor. With no connection (floating), OUTB is disabled. By grounding pin 6, OUTB is enabled. By enabling OUTB, this part will consume roughly 5 mA more current.

Typical Performance Data: V_{DD} = 3.0 V

Figure 4. Input Sensitivity

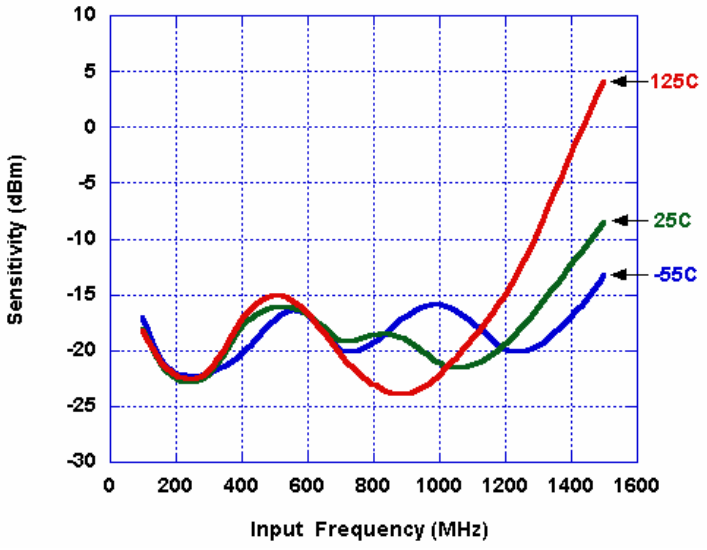


Figure 5. Device Current (OUTB Enabled)

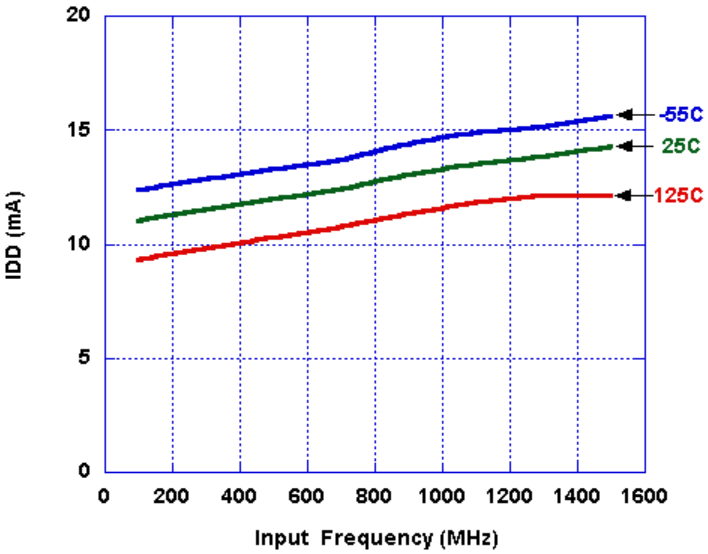
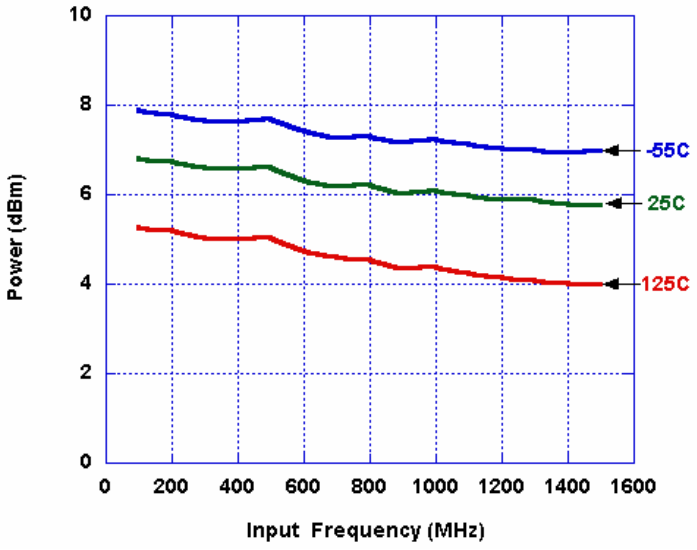


Figure 6. Output Power (OUT or OUTB)



Evaluation Kit

Evaluation Kit Operation

The *PE83511* EK board was designed to ease customer evaluation of Peregrine's high performance divide-by-2 Military Grade Prescaler. On this board, the device input (pin 2) is connected via connector J1 and a 50 Ω transmission line. A series capacitor (C3) provides the necessary DC block for the device input. It is important to note that the value of this capacitance will impact the performance of the device. A value of 1000 pF was found to be optimal for this board layout; other applications may require a different value.

The device output (pin 7) is connected to connector J3 through a 50 Ω transmission line. A series capacitor (C1) provides the necessary DC block for the device output. Note that this capacitor must be chosen to have low impedance at the desired output frequency the device. The value of 1000 pF was chosen to provide a wide operating range for the evaluation board.

The board is constructed of a two-layer FR4 material with a total thickness of 0.031". The bottom layer provides ground for the RF transmission lines. The transmission lines were designed using a coplanar waveguide above ground plane model with trace width of 0.030", trace gaps of 0.007", dielectric thickness of 0.028", metal thickness of 0.0014" and ε_r of 4.4. Note that the predominate mode for these transmission lines is coplanar waveguide.

J2 provides DC power to the device. Starting from the lower left pin, the second pin to the right (J2-3) is connected to the device VDD pin (1). Two decoupling capacitors (10 pF, 1000 pF) are included on this trace. It is the responsibility of the customer to determine proper supply decoupling for their design application.

Applications Support

If you have a problem with your evaluation kit or if you have applications questions call (858) 731-9400 and ask for applications support. You may also contact us by fax or e-mail:
Fax: (858) 731-9499
E-Mail: help@psemi.com

Figure 7. Evaluation Board Layouts
Peregrine Specification 101/0190

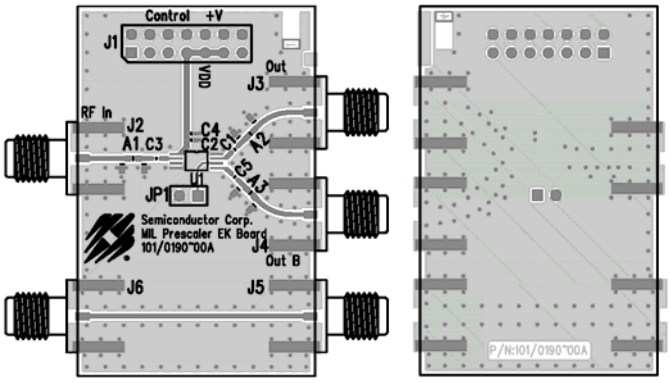


Figure 8. Evaluation Board Schematic
Peregrine Specification 102/0201

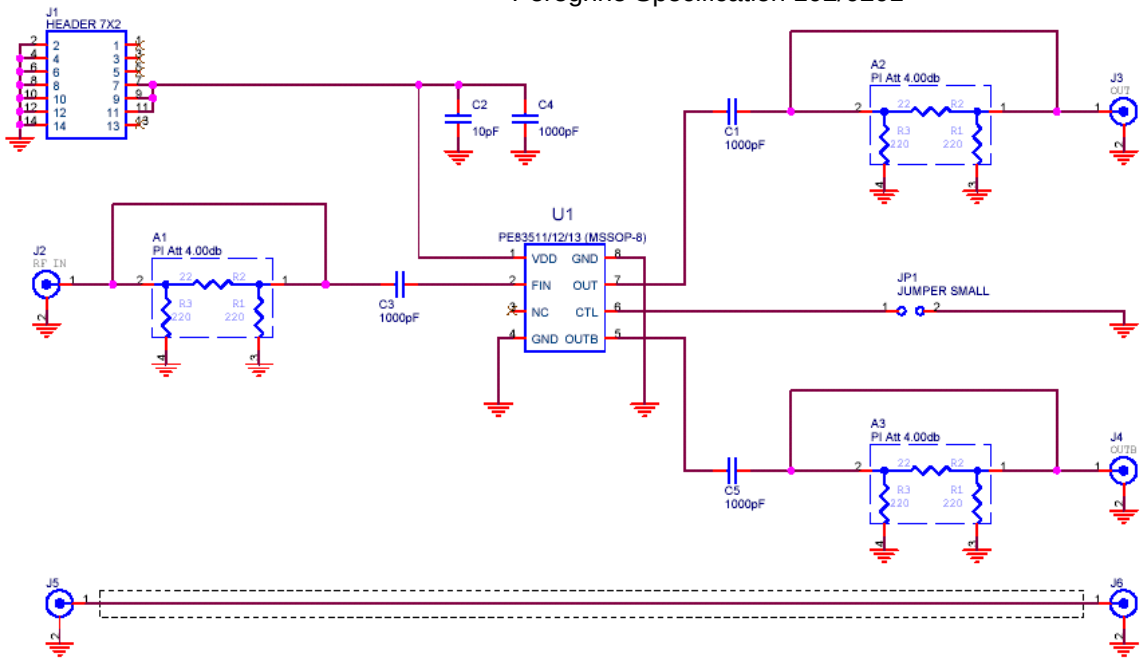


Figure 9. Package Drawing

8-lead MSOP

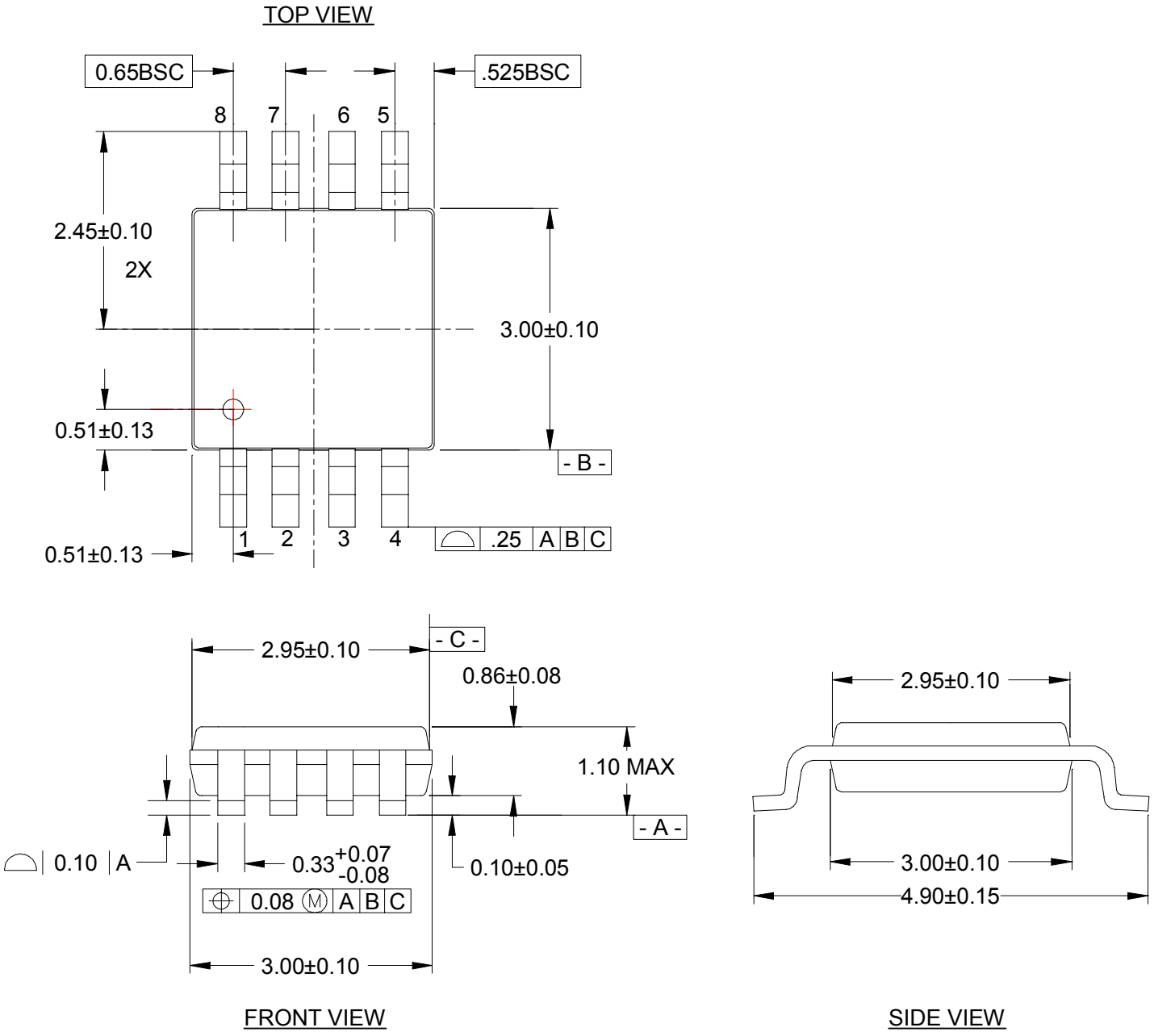
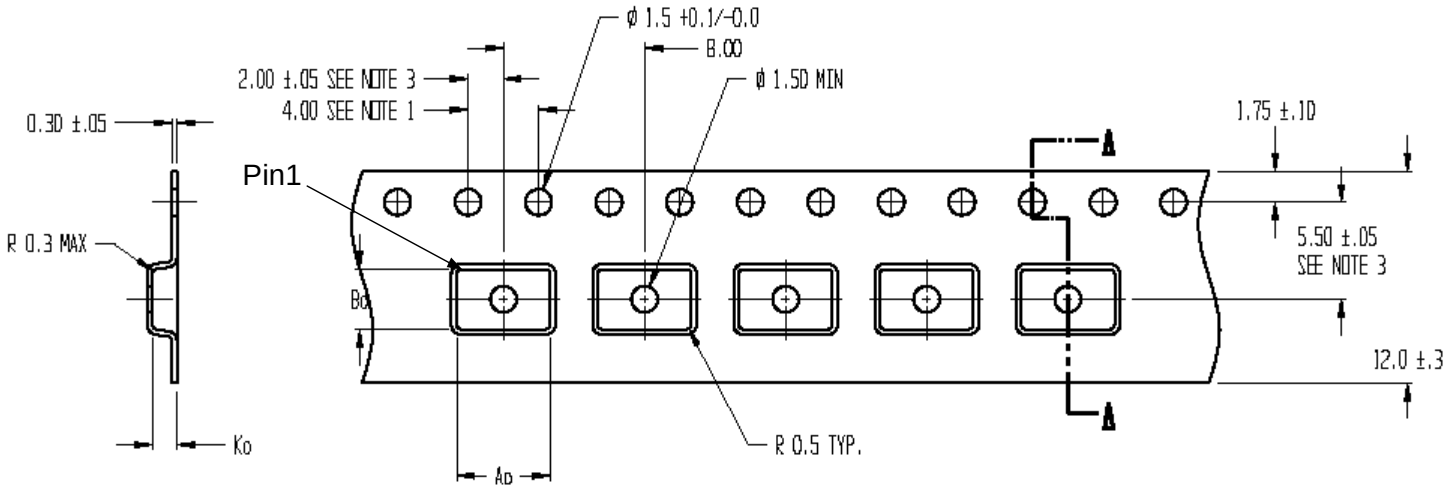


Figure 10. Tape and Reel Specifications

8-lead MSOP



Ao = 5.30
Bo = 3.40
Ko = 1.40

NOTES:
1. 10 SPROCKET HOLE PITCH CUMULATIVE TOLERANCE ±0.2
2. CAMBER IN COMPLIANCE WITH EIA 481
3. POCKET POSITION RELATIVE TO SPROCKET HOLE MEASURED AS TRUE POSITION OF POCKET, NOT POCKET HOLE

Table 4. Ordering Information

Order Code	Part Marking	Description	Package	Shipping Method
83511-01	PE83511	PE83511-08MSOP-50A	8-lead MSOP	50 units / Tube
83511-02	PE83511	PE83511-08MSOP-2000C	8-lead MSOP	2000 units / T&R
83511-00	PE83511-EK	PE83511-08MSOP-EK	Evaluation Kit	1 / Box

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Data Sheet Identification

Advance Information

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Preliminary Specification

The data sheet contains preliminary data. Additional data may be added at a later date. Peregrine reserves the right to change specifications at any time without notice in order to supply the best possible product.

Product Specification

The data sheet contains final data. In the event Peregrine decides to change the specifications, Peregrine will notify customers of the intended changes by issuing a DCN (Document Change Notice).

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